

Technical Data Sheet

1.8mm round Subminiature Chip LED

42-21A/R6C-AX1Y1B/1T

Features

- Package in 12mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The 42-21A SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications, etc.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

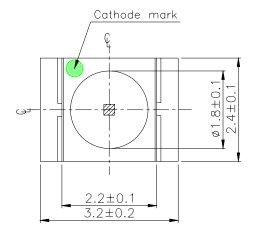
Device Selection Guide

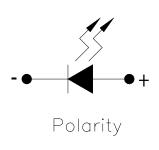
Part No.	Cl		
	Material	Emitted Color	Lens Color
42-21A/R6C-AX1Y1B/1T	AlGaInP	Brilliant Red	Water Clear

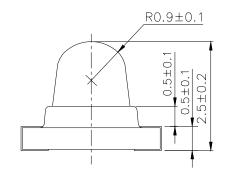
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 1 of 10

Device No.: DSE-42A-R04 Prepared date: 15-Aug-2005 Prepared by: Ashley Kuo

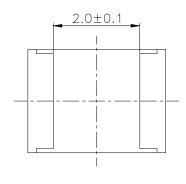
Package Outline Dimensions

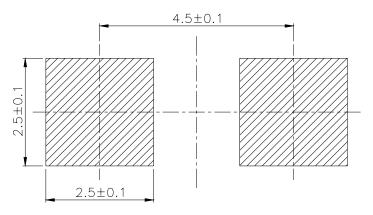






For reflow soldering (propose)





Note: Tolerances Unless Dimension ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 2 of 10 Device No.: DSE-42A-R04 Prepared date: 15-Aug-2005 Prepared by: Ashley Kuo



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	25	mA
Operating Temperature	Topr	-40 ~ +85	${\mathbb C}$
Storage Temperature	Tstg	-40~ +90	$^{\circ}\!\mathbb{C}$
Electrostatic Discharge (HBM)	ESD	2000	V
Power Dissipation	Pd	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	IFP	60	mA
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	1800		3600	mcd	
Viewing Angle	2 \theta 1/2		30		deg	
Peak Wavelength	λр		632		nm	
Dominant Wavelength	λd	617.5		633.5	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ		20		nm	
Forward Voltage	VF	1.75		2.35	V	
Reverse Current	IR			10	μΑ	V _R =5V

Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

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Device No.: DSE-42A-R04 Prepared date: 15-Aug-2005 Prepared by: Ashley Kuo



Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition	
A	E4	617.5	621.5			
	E5	621.5	625.5	nm	IF=20mA	
	E6	625.5	629.5			
	E7	629.5	633.5			

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
X1	1800	2250		
X2	2250	2850	mcd	IF=20mA
Y1	2850	3600		

Bin Range Of Forward Voltage

		U			
Group	Bin	Min	Max	Unit	Condition
	0	1.75	1.95		
В	1	1.95	2.15	V	IF=20mA
	2	2.15	2.35		

Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 4 of 10 Device No.: DSE-42A-R04 Prepared date: 15-Aug-2005 Prepared by: Ashley Kuo

50°

60°

70°

80°

0.1 0.2 0.4 0.6

Typical Electro-Optical Characteristics Curves

25

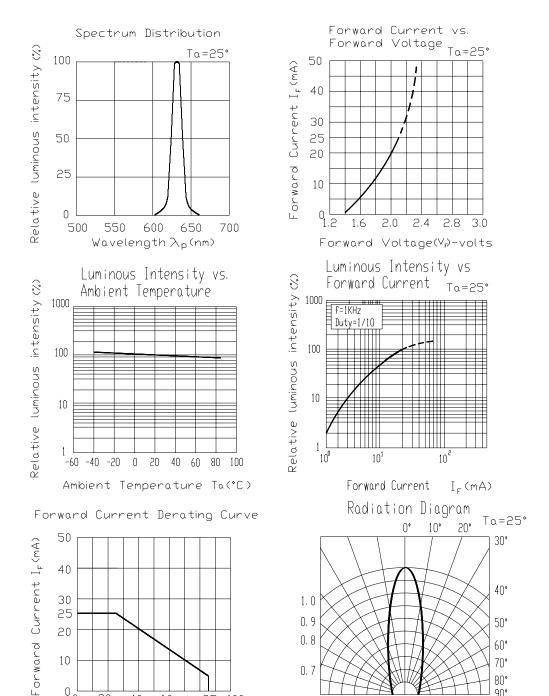
20

10

40

60

Ambient Temperature Ta(°C)



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0. 9

0.8

0.7

0.5 0.3

Label explanation

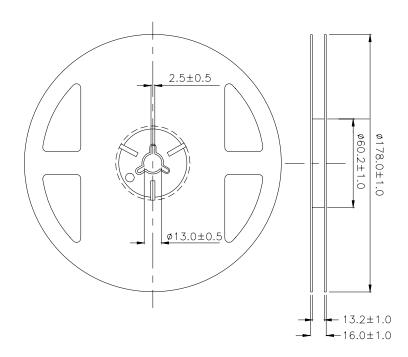
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions

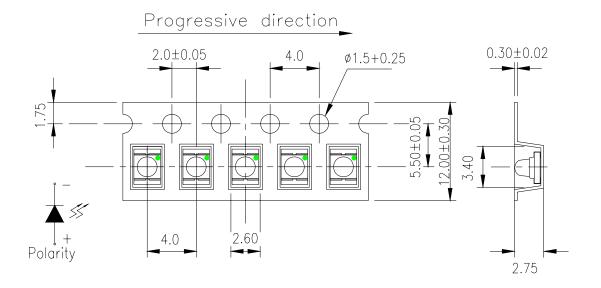


Note: Tolerances Unless Dimension ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 6 of 10

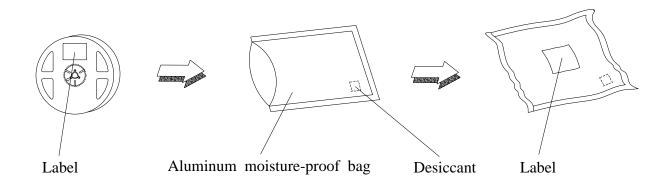
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Carrier Tape Dimensions: Loaded quantity 1000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Device No.: DSE-42A-R04 Prepared date: 15-Aug-2005 Prepared by: Ashley Kuo



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 8 of 10

Device No.: DSE-42A-R04 Prepared date: 15-Aug-2005 Prepared by: Ashley Kuo

Precautions For Use

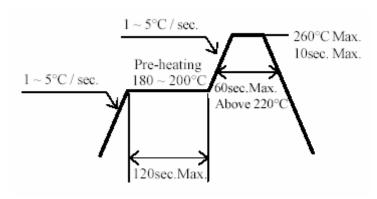
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 9 of 10

Device No.: DSE-42A-R04 Prepared date: 15-Aug-2005 Prepared by: Ashley Kuo

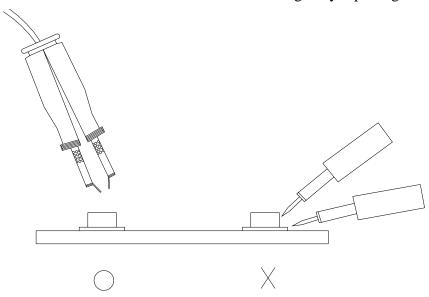


4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 10 of 10

Device No. : DSE-42A-R04 Prepared date: 15-Aug-2005 Prepared by: Ashley Kuo